2SB1179, 2SB1179A

Silicon PNP epitaxial planar type darlington

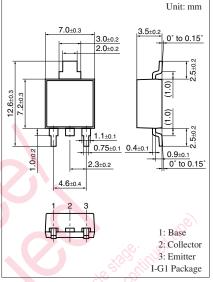
For power amplification and switching Complementary to 2SD1749, 2SD1749A

Features

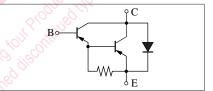
- \bullet High forward current transfer ratio $h_{F\!E}$ which has satisfactory linearity
- High-speed switching
- I type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment

Absolute Maximum Hatings $T_{\rm C} = 23$ C									
Parameter	Symbol	Rating	Unit						
Collector-base voltage	2SB1179	V _{CBO}	-60	V					
(Emitter open)	2SB1179A		-80						
Collector-emitter voltage	2SB1179	V _{CEO}	-60	V					
(Base open)	2SB1179A		-80						
Emitter-base voltage (Collector open)		V _{EBO}	-5	V					
Collector current		I _C	-4	A					
Peak collector current		I _{CP}	-8	Α					
Collector power dissipation		P _C	15	W					
	$T_a = 25^{\circ}C$		1.3						
Junction temperature		Tj	150	°C					
Storage temperature		T _{stg}	-55 to +150	°C					

Absolute Maximum Ratings $T_C = 25^{\circ}C$



Note) Self-supported type package is also prepared. Internal Connection



Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SB1179	V _{CEO}	$I_{\rm C} = -30 \text{ mA}, I_{\rm B} = 0$	-60			V
(Base open)	2SB1179A		in the sale	-80			
Base-emitter voltage		V _{BE}	$V_{CE} = -3 V, I_C = -3 A$			-2.5	V
Collector-base cutoff	2SB1179	I _{CBO}	$V_{CB} = -60 \text{ V}, I_E = 0$			-200	μΑ
current (Emitter open)	2SB1179A	200	$V_{CB} = -80 \text{ V}, I_E = 0$			-200	
Collector-emitter cutoff	2SB1179	ICEO	$V_{CE} = -40 \text{ V}, \text{ I}_{B} = 0$			-500	μΑ
current (Base open)	2SB1179A	all'i gi	$V_{CE} = -40 \text{ V}, I_B = 0$			-500	
Emitter-base cutoff current (Collector open)		I _{EBO}	$V_{EB} = -5 V, I_C = 0$			-2	mA
Forward current transfer ratio		h _{FE1}	$V_{CE} = -3 \text{ V}, I_C = -0.5 \text{ A}$	1 0 0 0			
		h _{FE2} *	$V_{CE} = -3 V, I_C = -3 A$	2 0 0 0		10 000	
Collector-emitter saturation voltage		V _{CE(sat)}	$I_{\rm C} = -3$ A, $I_{\rm B} = -12$ mA			-2	V
			$I_{\rm C} = -5$ A, $I_{\rm B} = -20$ mA			-4	
Transition frequency		f _T	$V_{CE} = -10 \text{ V}, I_C = -0.5 \text{ A}, f = 1 \text{ MHz}$		20		MHz
Turn-on time		t _{on}	$I_{C} = -3 \text{ A}, I_{B1} = -12 \text{ mA}, I_{B2} = 12 \text{ mA}$		0.3		μs
Storage time		t _{stg}	$V_{CC} = -50 \text{ V}$		2.0		μs
Fall time		t _f			0.5		μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

Ρ

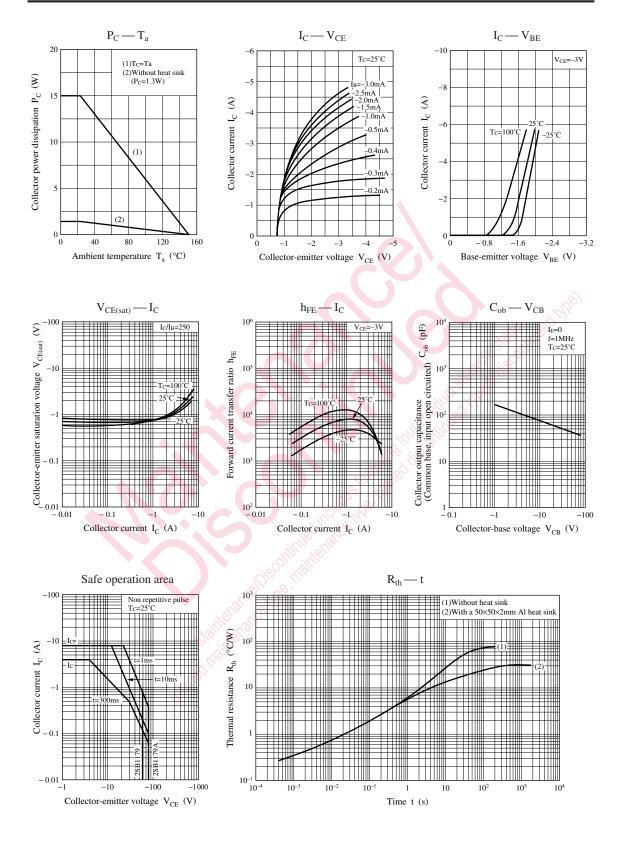
2. *: Rank classification

h_{FE2} 2000 to 5000 4000 to 10000

Q

Rank

Panasonic



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